

### SK102C THRU SK1010C

Reverse Voltage - 20 to 100 Volts Forward Current - 10.0 Ampere

#### SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER

#### **Features**

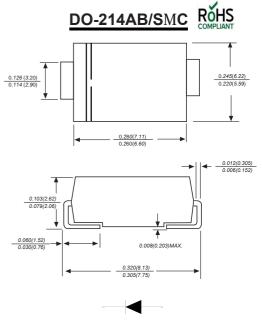
- ◆ The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- For surface mounted applications
- Metal silicon junction, majority carrier conduction
- Low power loss, high efficiency
- Built-in strain relief,ideal for automated placement
- High forward surge current capability
- High temperature soldering guaranteed:
   250 °C/10 seconds at terminals

## **Mechanical Data**

Case: JEDEC DO-214AB/SMC molded plastic body Terminals: Solderable per MIL-STD-750,Method 2026 Polarity: Color band denotes cathode end Mounting

Position: Any

Weight: 0.007 ounce, 0.25 grams



Dimensions in inches and (millimeters)

# **Maximum Ratings And Electrical Characteristics**

Ratings at 25 C ambient temperature unless otherwise specified.

Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.

Parameter		SK102C	SK103C	SK1035C	SK104C	SK1045C	SK106C	SK108C	SK1010C		
Marking Code	SYMBOLS	MDD SK102C	MDD SK103C	MDD SK1035C	MDD SK104C	MDD SK1045C	MDD SK106C	MDD SK108C	MDD SK1010C	UNITS	
Maximum repetitive peak reverse voltage	Vrrm	20	30	35	40	45	60	80	100	V	
Maximum RMS voltage	Vrms	14	21	24.5	28	31.5	42	56	70	V	
Maximum DC blocking voltage	VDC	20	30	35	40	45	60	80	100	V	
Maximum average forward rectified current at TL(see fig.1)	l(AV)	10.0					А				
Peak forward surge current											
8.3ms single half sine-wave	IFSM	250							A		
superimposed onrated load (JEDEC Method)											
Maximum instantaneous forward voltage at 10.0A	VF	0.65 0.85			5	V					
Maximum DC reverse current Ta=25 ℃		1.0						mA			
at rated DCblocking voltage T <sub>A</sub> =125°C	lR	20									
Typical junction capacitance (NOTE 1)	Cı	500				pF					
Typical thermal resistance (NOTE 2)	RθJA	18.0			°C/W						
Operating junction temperature range	Тı	-50 to +150			$^{\circ}$						
Storage temperature range	Тѕтс	-50 to +150				$^{\circ}$					

Note: 1. Measured at 1MHz and applied reverse voltage of 4.0 V D.C. 2.P.C.B. mounted with 0.2x0.2" (5.0x5.0mm) copper pad areas



### **Typical Characterisitics**

Figure 1 Typical Forward Characteristics

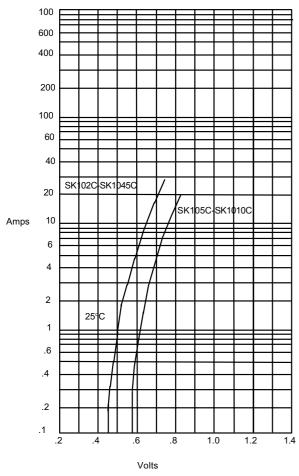


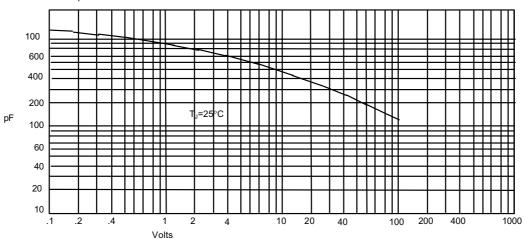
Figure 2
Forward Derating Curve

12
10
8.0
8.0
4.0
2.0
Single Phase, Half Wave
001 z Resistive or Inductive Lead
0 60 80 100 120 140 160 180

°C
Average Forward Rectified Current - Amperes *versus*Lead Temperature - C

Instantaneous Forward Current - Amperes *versus* Instantaneous Forward Voltage - Volts

Figure 3 Junction Capacitance



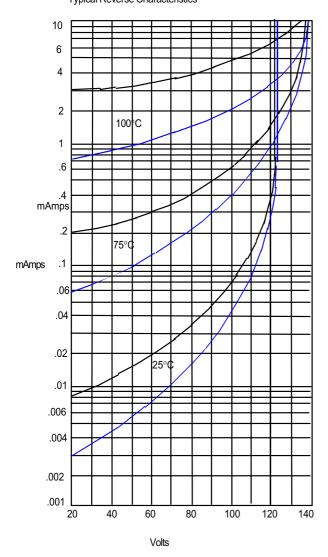
Junction Capacitance - pF versus

The curve above is for reference only.

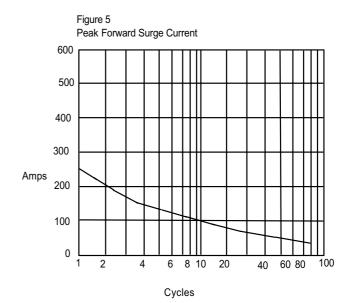
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# **Typical Characterisitics**

Figure 4
Typical Reverse Characteristics



Instantaneous Reverse Leakage Current - MicroAmperes *versus*Percent Of Rated Peak Reverse Voltage - Volts



Peak Forward Surge Current - Amperes *versus* Number Of Cycles At 60Hz - Cycles

The curve above is for reference only.

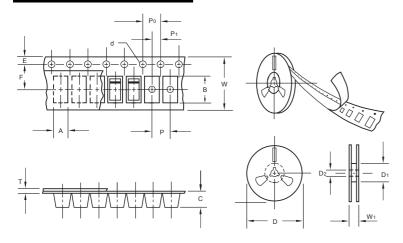


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### **Packing information**

unit:mm



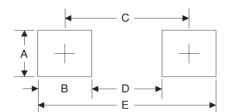
ltem	Symbol	Tolerance	SMC	
Carrier width	Α	0.1	6.15	
Carrier length	В	0.1	8.41	
Carrier depth	С	0.1	2.42	
Sprocket hole	d	0.05	1.50	
13" Reel outside diameter	D	2.0	330.00	
13" Reel inner diameter	D1	min	50.00	
Feed hole diameter	D2	0.5	13.00	
Sprocket hole position	E	0.1	1.75	
Punch hole position	F	0.1	7.50	
Punch hole pitch	Р	0.1	8.00	
Sprocket hole pitch	P <sub>0</sub>	0.1	4.00	
Embossment center	P1	0.1	2.00	
Overall tape thickness	T	0.1	0.25	
Tape width	W	0.3	16.00	
Reel width	W1	1.0	16.50	

Note: Devices are packed in accordance with EIA standar RS-481-A and specifications listed above.

# Reel packing

PACKAGE	REEL SIZE	REEL (pcs)	COMPONENT SPACING (mm)	BOX (pcs)	INNER BOX (mm)	REEL DIA, (mm)	CARTON SIZE (mm)	CARTON (pcs)	APPROX. GROSS WEIGHT (kg)
SMC	13"	3,000	4.0	6000	190*190*41	330	365*365*340	42000	14.0

### **Suggested Pad Layout**



Symbol	Unit (mm)	Unit (inch)
Α	4.3	0.170
В	4.1	0.160
С	7.9	0.311
D	3.8	0.150
Е	12	0.472

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